



JOCHC15B-L5X Series

Rev.A.1.0

DESCRIPTION:

The products are 15MBd high-speed opto-couplers in the LSOP5 and LSOP5W package. The device consists of a 850 nm AlGaAS LED, optically coupled to a very high speed integrated photo-detector logic gate. The output end of the device is a CMOS output, and the device has a strong common mode rejection capability. The products are widely used in communication interface, digital isolation for A/D, D/A conversion, renewable energy inverters, medical imaging and patient monitoring.

MAIN FEATURES

- High isolation 5000 VRMS
- High speed – 15MBd typical
- Operating temperature range -40°C to 110°C
- REACH & RoHS compliance
- HBM: H3A; MM: M4; CDM: C3
- CQC approved
- VDE approved
- UL approved



Truth Table

| LED | Output V_o |
|-----|--------------|
| ON | L |
| OFF | H |

ABSOLUTE MAXIMUM RATINGS (Temperature=25°C)

| Parameter | | Symbol | Value | Unit |
|-----------|-------------------------|----------|----------------|------|
| Input | Forward Current | I_F | 50 | mA |
| | Peak Forward Current | I_{FP} | 1 ^① | A |
| | Reverse Voltage | V_R | 6 | V |
| | Input Power Dissipation | P_D | 100 | mW |
| Output | Supply Voltage | V_{CC} | 7 | V |

| | | | | |
|-------------------------|--------------------------|-----------|-------------------|------------------|
| | Output Voltage | V_o | $V_{CC}+0.5$ | V |
| | Output Current | I_o | 10 | mA |
| | Output Power Dissipation | P_o | 22 | mW |
| Total Power Dissipation | | P_{tot} | 130 | mW |
| Isolation Voltage | | V_{iso} | 5000 ^② | V _{rms} |
| Operating Temperature | | T_{opr} | -40~110 | °C |
| Junction Temperature | | T_j | 125 | °C |
| Storage Temperature | | T_{stg} | -55~125 | °C |
| Soldering Temperature | | T_{sol} | 260 | °C |

NOTE1 : 100μs pulse, 100Hz frequency

NOTE2 : AC for 1minute, R.H.=40~60%

ELECTRICAL CHARACTERISTICS (Temperature=25°C)

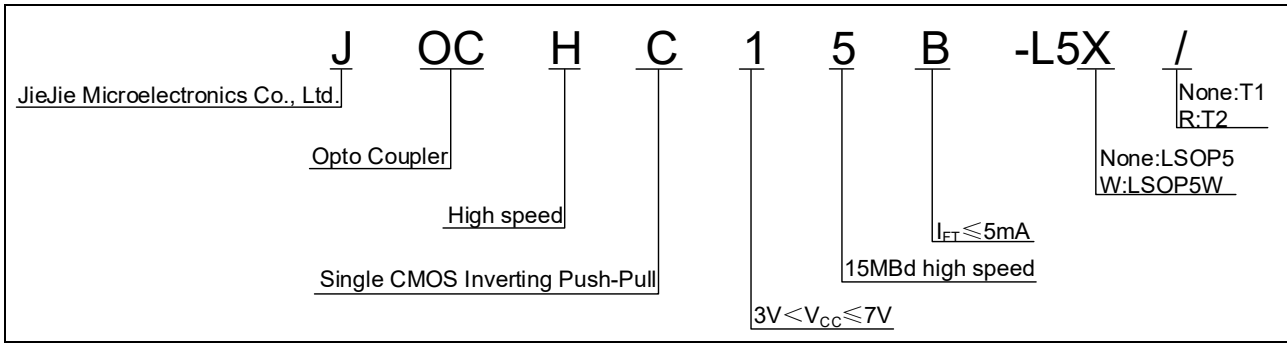
| Parameter | | Symbol | Condition | Min. | Typ. | Max. | Unit |
|---------------------------|--------------------------------------|-----------|-----------------------------------|--------------|----------|------|------|
| Input | Forward Voltage | V_F | $I_F=10mA$ | - | 1.35 | 1.6 | V |
| | Input Reverse Breakdown Voltage | BV_R | $I_R=10\mu A$ | 5 | - | - | V |
| | Reverse Current | I_R | $V_R=6V$ | - | - | 1 | μA |
| | Input Capacitance | C_{in} | $V=0, f=1MHz$ | - | 30 | 100 | pF |
| Output | High Level Supply Current | I_{CCH} | $V_{CC}=5V, I_F=0mA$ | - | - | 6.5 | mA |
| | Low Level Supply Current | I_{CCL} | $V_{CC}=5V, I_F=10mA$ | - | - | 6.5 | mA |
| | Logic High Output Voltage | V_{OH} | $I_F=0mA, I_o=-20\mu A$ | $V_{DD}-0.1$ | V_{DD} | - | V |
| | Logic Low Output Voltage | V_{OL} | $I_F=7mA, I_o=20\mu A, V_{CC}=5V$ | - | 0.02 | 0.1 | V |
| | Isolation Resistance | R_{iso} | DC500V 40~60%R.H. | 10^{12} | - | - | Ω |
| | Floating Capacitance | C_{IO} | $f=1MHz$ | - | 0.6 | - | pF |
| Switching Characteristics | Trigger LED Current | I_{FT} | $V_{CC}=5V$ | - | - | 5 | mA |
| | Propagation Delay Time to Logic Low | TPHL | $I_F=7mA, C_L=15pF$ | - | 70 | 100 | ns |
| | Propagation Delay Time to Logic High | TPLH | $I_F=7mA, C_L=15pF$ | - | 55 | 100 | ns |

| | | | | | | | |
|--|--|-----------------|---|----|----|---|-------|
| | Common Mode Transient Immunity at Logic High | CM _H | I _F =0mA, V _{CM} =1000Vpp, C _L =15pF, V _{CC} =5V | 20 | - | - | kV/μs |
| | Common Mode Transient Immunity at Logic Low | CM _L | I _F =7mA, V _{CM} =1000Vpp, C _L =15pF, V _{CC} =5V | 20 | - | - | kV/μs |
| | Output Rise Time | t _r | I _F =7mA,C _L =15pF | - | 10 | - | ns |
| | Output Fall Time | t _f | | - | 10 | - | |

Recommended Operating Conditions

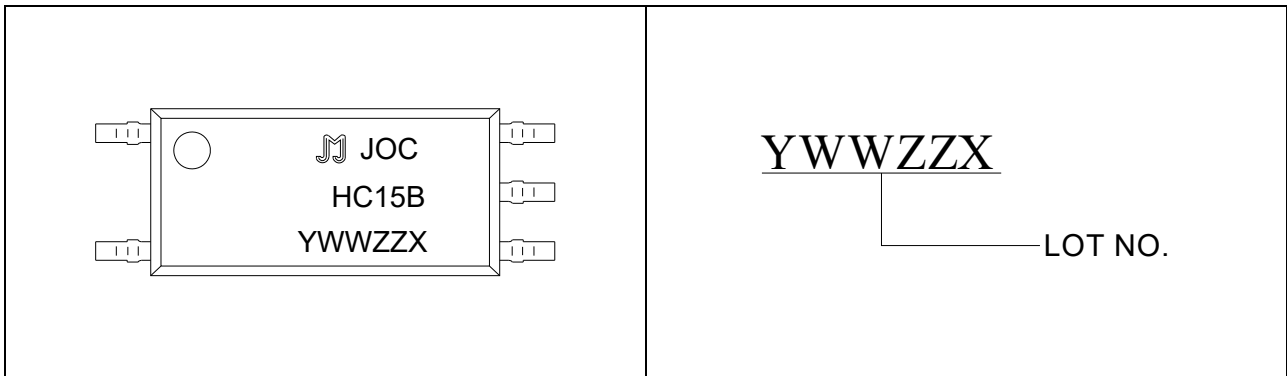
| Characteristics | Symbol | Min. | Typ. | Max. | Unit |
|--------------------------|---------------------|------|------|------|------|
| Operating Temperature | T _a | -40 | - | 105 | °C |
| Supply Voltage | V _{CC} | 2.7 | - | 5.5 | V |
| Low Level Input Current | I _{FL} | 0 | - | 250 | μA |
| High Level Input Current | I _{FH} | 8 | - | 16 | mA |
| Forward Voltage | V _{F(OFF)} | - | - | 0.8 | V |

ORDERING INFORMATION



| Packing Quantity | |
|------------------|-----------------|
| Option | Quantity |
| None/R | 3000 Units/Reel |

MARKING



Characteristics Curves

FIG.1: Forward Current vs. Forward Voltage

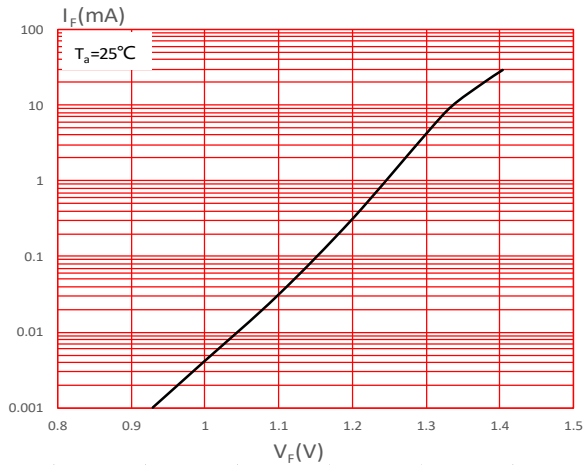


FIG.2: Max. Allowable LED Forward Current vs. Ambient Temperature

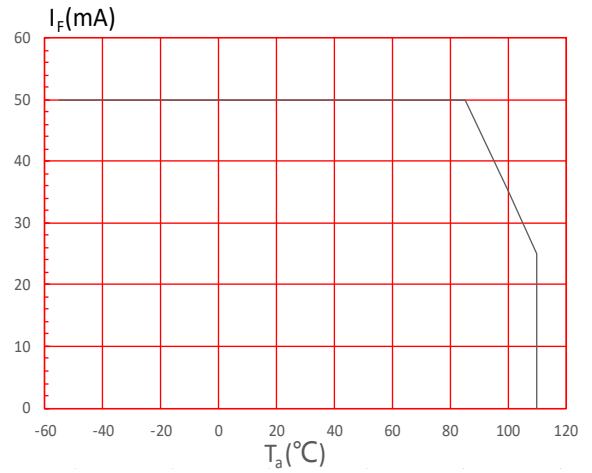


FIG.3: Logic High Output Supply Current vs. Ambient Temperature

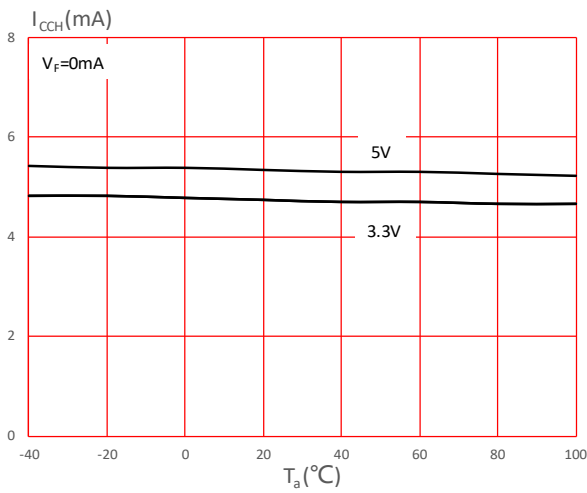


FIG.4: Logic Low Output Supply Current vs. Ambient Temperature

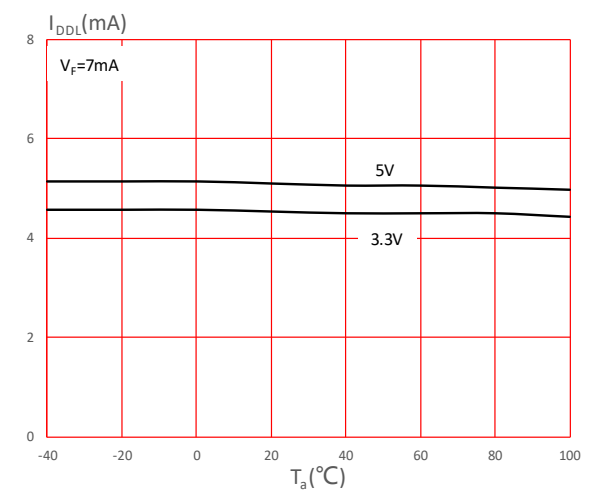


FIG.5: Propagation Delay vs. Ambient Temperature

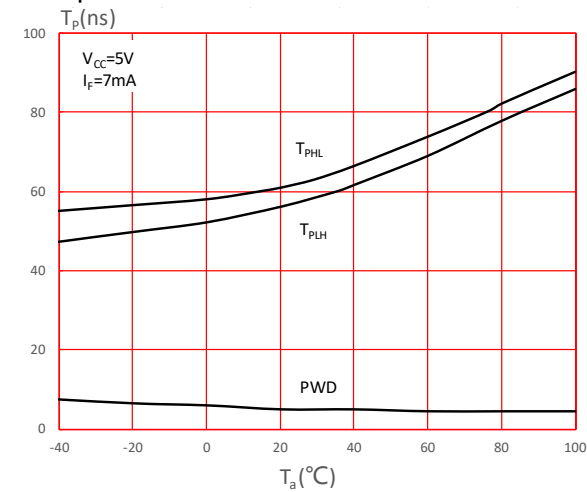


FIG.6: Input Threshold Current vs. Ambient Temperature

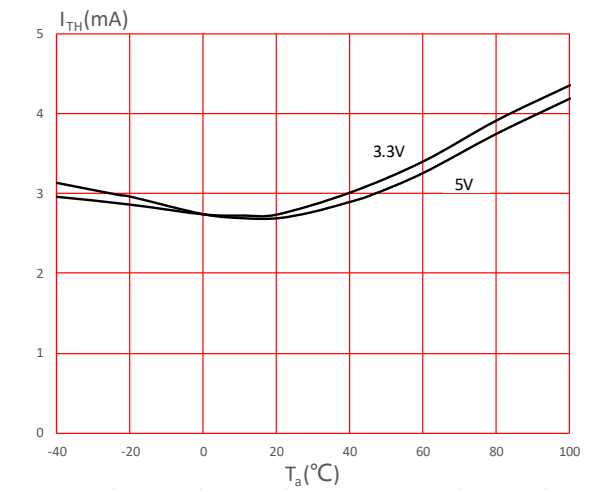


FIG.7: Propagation Delay vs. Ambient Temperature

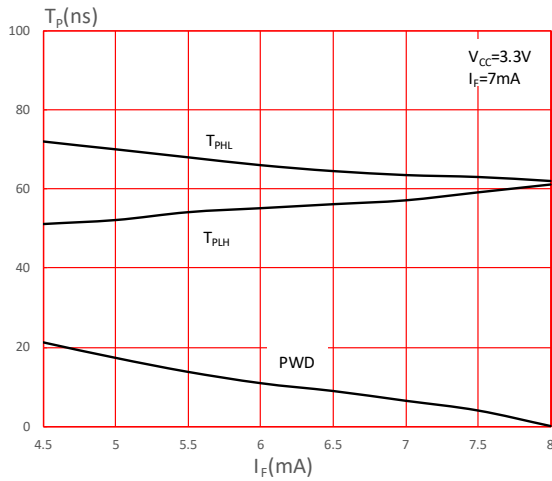
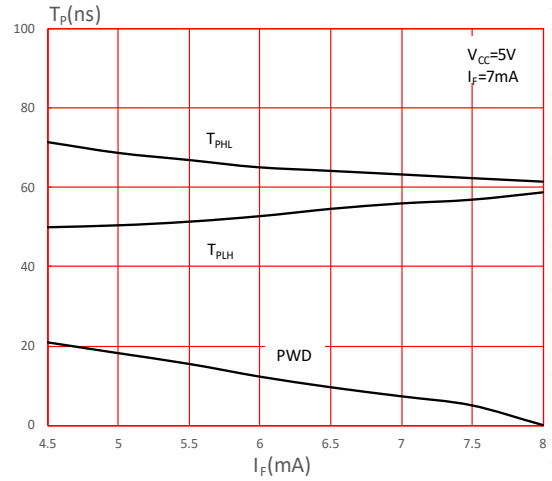


FIG.8: Propagation Delay vs. Ambient Temperature



TEST CIRCUITS

Fig.9: Switching Time Test Circuit and Waveform

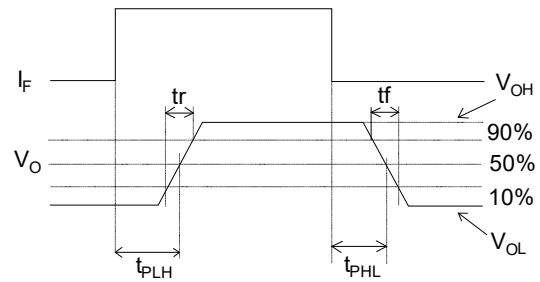
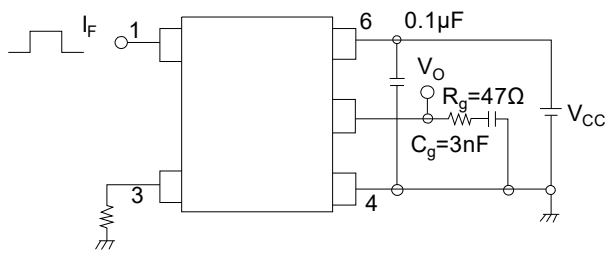
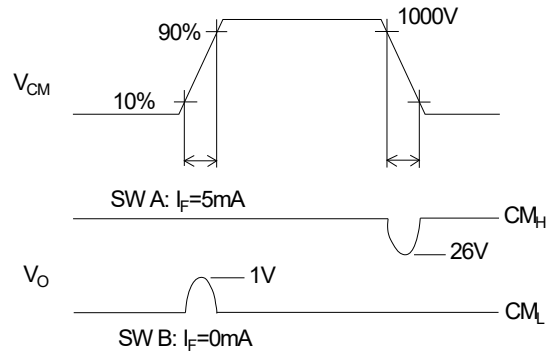
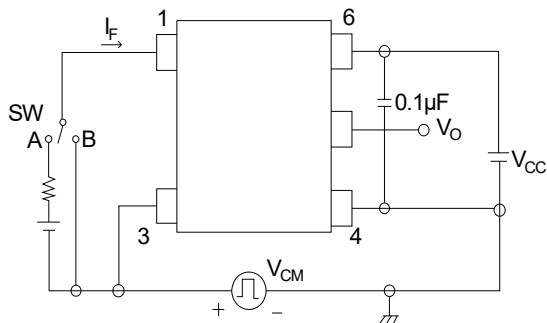
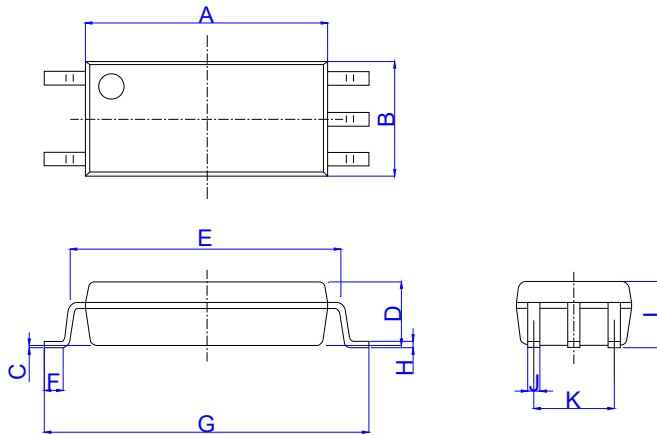


Fig.10: CMTI Test Circuit and Waveform



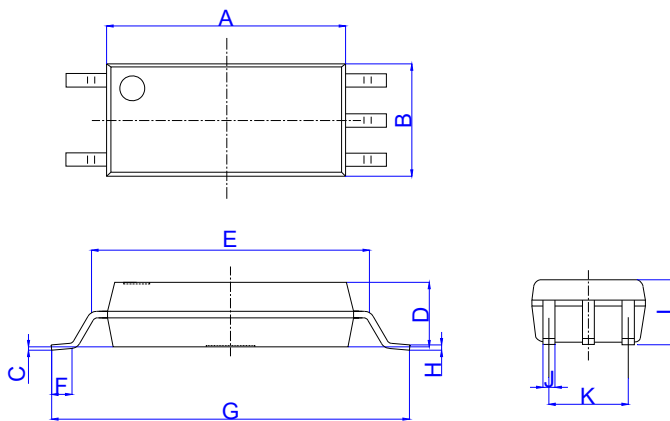
Package Dimension (Unit: mm)

LSOP5



| Ref. | Dimensions | | | | | |
|------|-------------|------|-------|--------|------|-------|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 7.40 | | 7.80 | 0.291 | | 0.307 |
| B | 3.40 | | 3.80 | 0.134 | | 0.150 |
| C | 0.00 | | 0.20 | 0.000 | | 0.008 |
| D | 1.80 | | 2.20 | 0.071 | | 0.087 |
| E | 8.10 | | 8.70 | 0.319 | | 0.343 |
| F | 0.40 | | 1.00 | 0.016 | | 0.039 |
| G | 9.90 | | 10.50 | 0.390 | | 0.413 |
| H | 0.10 | | 0.30 | 0.004 | | 0.012 |
| I | 1.80 | | 2.40 | 0.071 | | 0.094 |
| J | 0.25 | | 0.55 | 0.010 | | 0.022 |
| K | 2.29 | | 2.79 | 0.090 | | 0.110 |

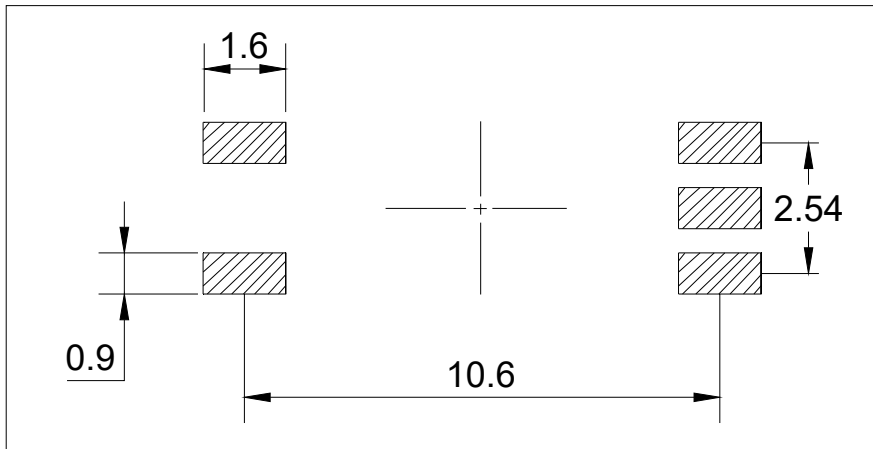
LSOP5W



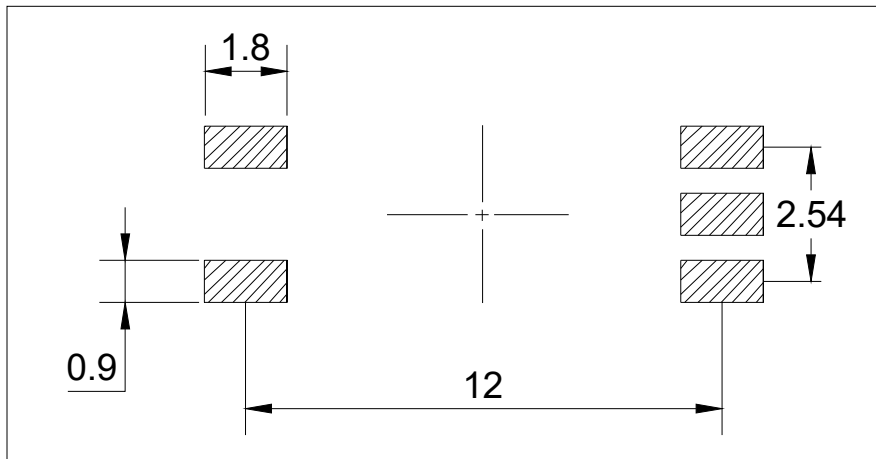
| Ref. | Dimensions | | | | | |
|------|-------------|------|-------|--------|------|-------|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 7.40 | | 7.80 | 0.291 | | 0.307 |
| B | 3.40 | | 3.80 | 0.134 | | 0.150 |
| C | 0.00 | | 0.20 | 0.000 | | 0.008 |
| D | 1.80 | | 2.20 | 0.071 | | 0.087 |
| E | 8.10 | | 8.70 | 0.319 | | 0.343 |
| F | 0.55 | | 1.15 | 0.022 | | 0.045 |
| G | 10.78 | | 11.38 | 0.424 | | 0.448 |
| H | 0.06 | | 0.26 | 0.002 | | 0.010 |
| I | 1.80 | | 2.40 | 0.071 | | 0.094 |
| J | 0.25 | | 0.55 | 0.010 | | 0.022 |
| K | 2.29 | | 2.79 | 0.090 | | 0.110 |

RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated)

LSOP5

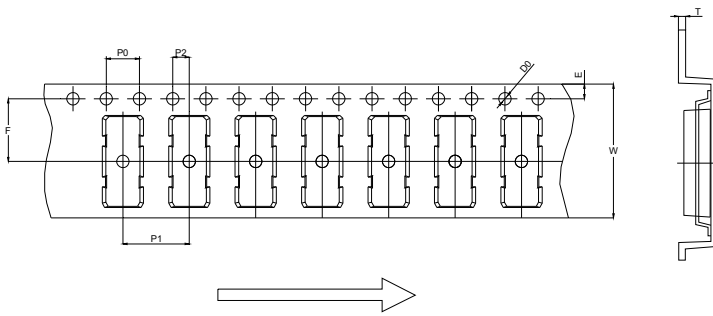


LSOP5W



CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option None/R



| Ref. | Dimensions | | | | | |
|------|-------------|-------|-------|--------|-------|-------|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| D0 | 1.50 | 1.55 | 1.60 | 0.059 | 0.061 | 0.063 |
| P0 | 3.90 | 4.00 | 4.10 | 0.154 | 0.157 | 0.161 |
| P1 | 7.90 | 8.00 | 8.10 | 0.311 | 0.315 | 0.319 |
| P2 | 1.90 | 2.00 | 2.10 | 0.075 | 0.079 | 0.083 |
| E | 1.65 | 1.75 | 1.85 | 0.065 | 0.069 | 0.073 |
| F | 7.40 | 7.50 | 7.60 | 0.291 | 0.295 | 0.299 |
| T | 0.35 | 0.40 | 0.45 | 0.014 | 0.016 | 0.018 |
| W | 15.80 | 16.00 | 16.20 | 0.622 | 0.630 | 0.638 |

REFLOW INFORMATION




| Profile Feature | Sn-Pb Assembly Profile | Pb-Free Assembly Profile |
|---|------------------------|--------------------------|
| Temperature Min. (T _{smin}) | 100 | 150°C |
| Temperature Max. (T _{smax}) | 150 | 200°C |
| Time (t _s) from (T _{smin} to T _{smax}) | 60-120 seconds | 60-120 seconds |
| Ramp-up Rate (t _L to t _P) | 3°C/second max. | 3°C/second max. |
| Liquidus Temperature (T _L) | 183°C | 217°C |
| Time (t _L) Maintained Above (T _L) | 60-150 seconds | 60-150 seconds |
| Peak Body Package Temperature | 235°C+0°C/-5°C | 260°C+0°C/-5°C |
| Time (t _P) within 5°C of 260°C | 20 seconds | 30 seconds |
| Ramp-down Rate (T _P to T _L) | 6°C/second max. | 6°C/second max. |
| Time 25°C to Peak Temperature | 6 minutes max. | 8 minutes max. |

Note:

1. Reflow soldering is recommended at the temperatures and times shown, no more than three times.
2. Avoid direct contact between the epoxy body and any tools or surfaces exceeding its maximum storage temperature.
3. Application of pressure on the epoxy body is prohibited at elevated temperatures. In specific scenarios, any applied force must not exceed 2.5N.
4. Ensure the component has cooled to ambient temperature before proceeding with any subsequent manufacturing steps.
5. The component has a shelf life of one year when stored under standard conditions.
6. Recommend storage Temp.: 0~40°C;
Recommend storage humidity: <60%;
MSL level: MSL 1

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